



## UT50N04H

Preliminary

Power MOSFET

### 50A, 40V N-CHANNEL POWER MOSFET

#### DESCRIPTION

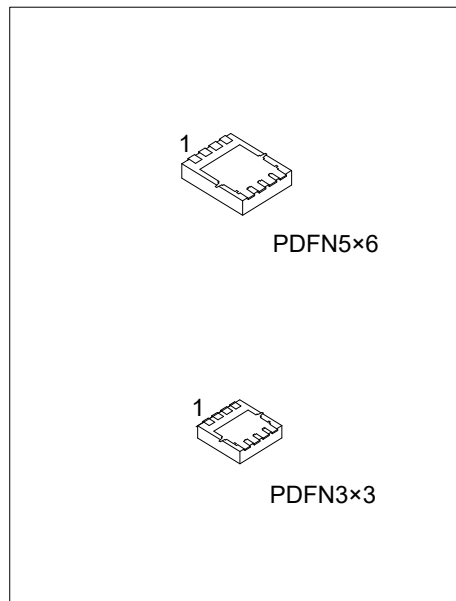
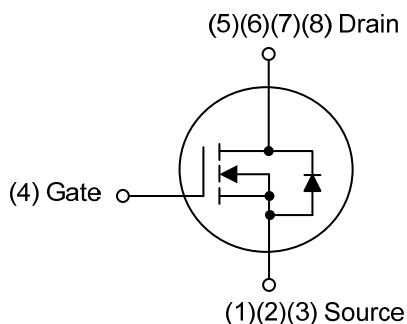
The UTC **UT50N04H** is a N-channel enhancement MOSFET using UTC's advanced technology to provide the customers with perfect  $R_{DS(ON)}$  and high switching speed.

#### FEATURES

\*  $R_{DS(ON)} \leq 5.3 \text{ m}\Omega$  @  $V_{GS}=10\text{V}$ ,  $I_D=25\text{A}$

\* High Switching Speed

#### SYMBOL



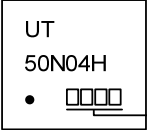
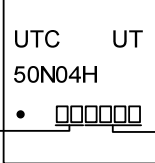
#### ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UT50N04HL-P3030-R	UT50N04HG-P3030-R	PDFN3x3	S	S	S	G	D	D	D	D	Tape Reel
UT50N04HL-P5060-R	UT50N04HG-P5060-R	PDFN5x6	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: S: Source G: Gate D: Drain

UT50N04HG-P3030-R	(1)Packing Type	(1) R: Tape Reel
	(2)Package Type	(2) P3030: PDFN3x3, P5060: PDFN5x6
	(3)Green Package	(3) G: Halogen Free and Lead Free, K: Lead Free

### MARKING

PDFN3×3	PDFN5×6
 <p>UT 50N04H • □□□□ → Date Code</p>	 <p>UTC    UT 50N04H • □□□□□□ → Date Code ← Lot Code</p>

# ■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DS}$	40	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Drain Current	Continuous ( $V_{GS}=10V$ )	$I_D$	50	A
	Pulsed (Note 2)	$I_{DM}$	100	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	84	mJ
Peak Diode Recovery $dv/dt$ (Note 4)		$dv/dt$	1.1	V/ns
Power Dissipation	PDFN3×3	$P_D$	32	W
	PDFN5×6		41	W
Junction Temperature		$T_J$	+150	°C
Storage Temperature		$T_{STG}$	-55 ~ +175	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3.  $L = 0.1mH$ ,  $I_{AS} = 41A$ ,  $V_{DD} = 25V$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ C$

4.  $I_{SD} \leq 30A$ ,  $di/dt \leq 200A/\mu s$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ C$

# ■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	PDFN3×3	$\theta_{JA}$	75 (Note)	°C/W
	PDFN5×6		65 (Note)	°C/W
Junction to Case	PDFN3×3	$\theta_{JC}$	3.9 (Note)	°C/W
	PDFN5×6		3.04 (Note)	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

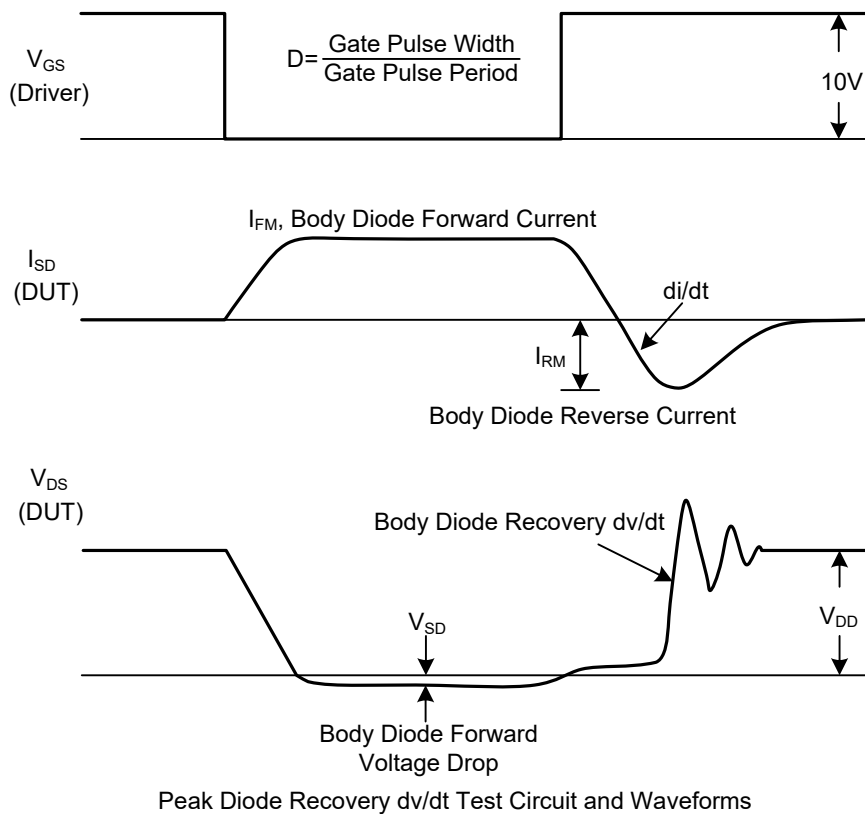
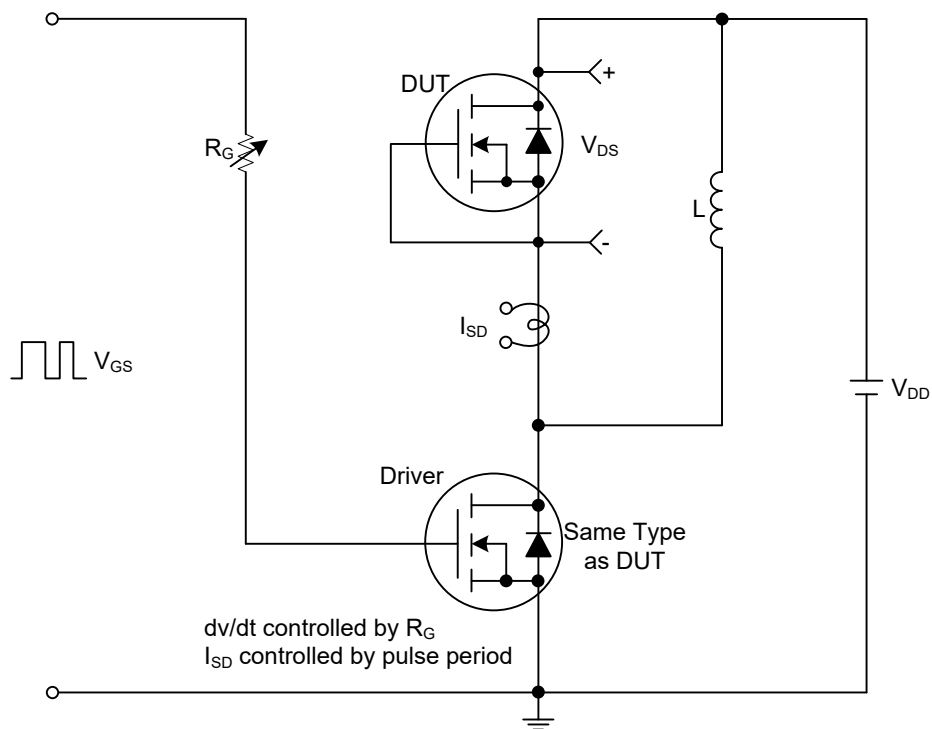
■ ELECTRICAL CHARACTERISTICS ( $T_J=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	40			V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V			1	μA
Gate- Source Leakage Current	Forward	I <sub>GSS</sub>	V <sub>GS</sub> =+20V, V <sub>DS</sub> =0V			+100	nA
	Reverse		V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2.0		4.0	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =25A			5.3	mΩ
DYNAMIC PARAMETERS							
Input Capacitance		C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz		2307		pF
Output Capacitance		C <sub>OSS</sub>			268		pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			211		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q <sub>G</sub>	V <sub>DS</sub> =32V, V <sub>GS</sub> =10V, I <sub>D</sub> =50A (Note 2)		62		nC
Gate to Source Charge		Q <sub>GS</sub>			8		nC
Gate to Drain Charge		Q <sub>GD</sub>			34		nC
Turn-ON Delay Time		t <sub>D(ON)</sub>	V <sub>DD</sub> =20V, V <sub>GS</sub> =10V, I <sub>D</sub> =50A, R <sub>G</sub> =3.3Ω, (Note 2)		12		ns
Rise Time		t <sub>R</sub>			15		ns
Turn-OFF Delay Time		t <sub>D(OFF)</sub>			42		ns
Fall-Time		t <sub>F</sub>			27		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Continuous Drain-Source Diode Forward Current		I <sub>S</sub>				50	A
Maximum Pulsed Drain-Source Diode Forward Current		I <sub>SM</sub>				100	A
Drain-Source Diode Forward Voltage		V <sub>SD</sub>	I <sub>S</sub> =50A, V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Time		t <sub>rr</sub>	I <sub>F</sub> =30A, V <sub>GS</sub> =0V, di/dt=100A/μs		19		ns
Body Diode Reverse Recovery Charge		Q <sub>rr</sub>			5		nC

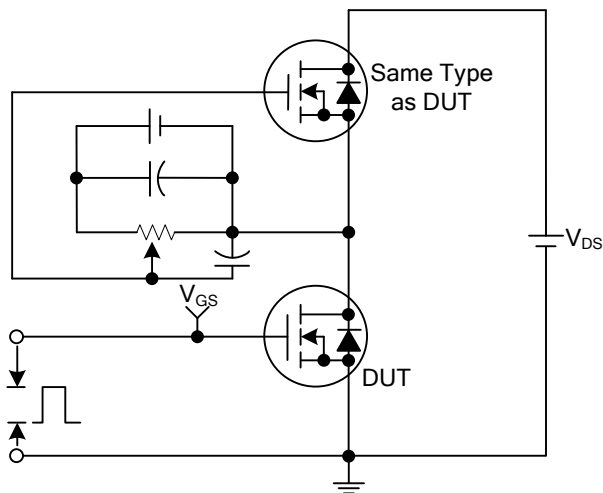
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating ambient temperature.

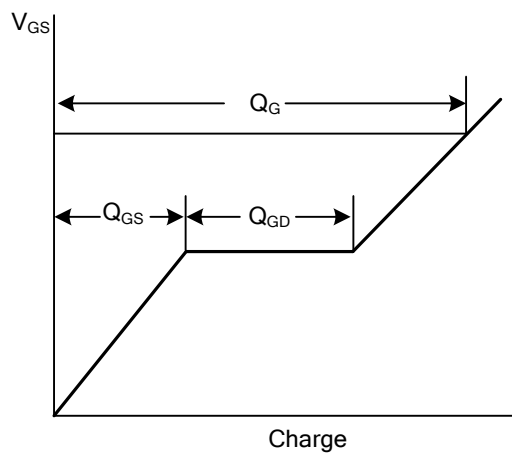
# ■ TEST CIRCUITS AND WAVEFORMS



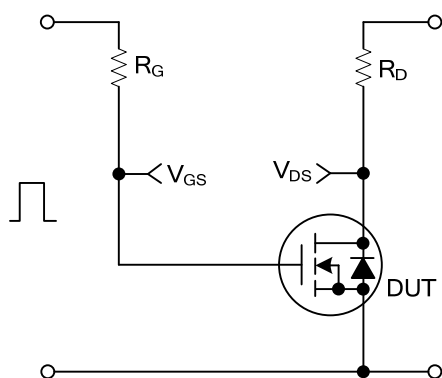
### ■ TEST CIRCUITS AND WAVEFORMS



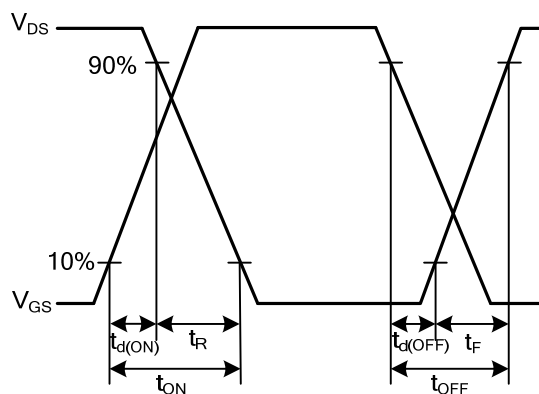
Gate Charge Test Circuit



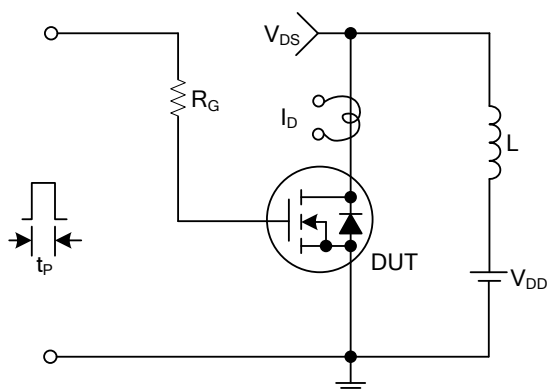
Gate Charge Waveforms



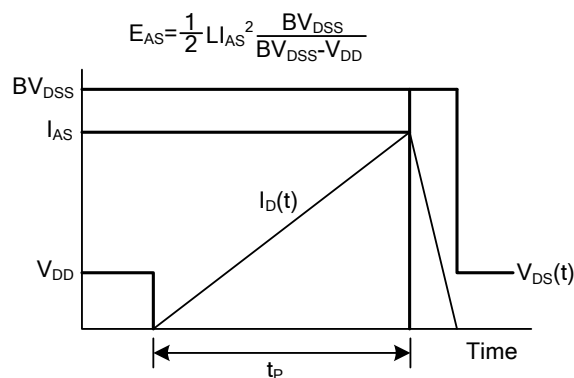
Resistive Switching Test Circuit



Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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